

H atom generation and loss kinetics in VHF plasmas

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We study hydrogen (H) atom generation and loss kinetics in capacitively coupled low pressure H₂ plasma. The H atom density has been measured by using vacuum ultra violet absorption spectroscopy (VUVAS), under two different electrode setups: conventional diode (direct) and triode with an intermediate mesh (remote). In the triode setup, the H atom density is strongly reduced across the mesh electrode; it varies from 10¹² cm⁻³ to 10¹⁰ cm⁻³ across the mesh. The fluid model simulations for VHF discharges have been performed to study the details of the H atom generation, diffusion and recombination kinetics.

A H atom is widely known to be reactive species, which reacts easily with other gas-phase species and various material surfaces. So, its reaction kinetics often plays key roles in plasma processing. So far, the H atom kinetics has been studied in “direct” plasma configuration. However, it is not studied for the “remote” plasma configuration that has advantages of less-ion bombardment and reduced surface charging.

Here, we study the H atom kinetics in capacitively-coupled very high frequency (VHF) discharges not only in direct (diode) configuration but also in remote (triode) configuration. The H atom density is experimentally determined from VUVAS [1]. The fluid model simulations of VHF discharges are performed to study the H atom kinetics.

Figure 1 shows the measurement results of the H atom density, n_H , in VHF H₂ discharges [2]. It is found that n_H is of the order of 10¹² cm⁻³ in the discharge region, whereas it is of the order of 10¹⁰ cm⁻³ in the processing region under the remote configuration. For our mesh geometry, i.e., a mesh with 0.2 mm in thickness and 36% in aperture ratio, n_H varies two orders of magnitude across the mesh.

Figure 2 shows the simulation results. As shown Fig. 2(a), n_H is broadly peaked at the middle of the discharge region. The peak value is recognized to be $\sim 1.0 \times 10^{12}$ cm⁻³, which is in good agreement with that measured by VUVAS in this study. The H atoms are generated mainly in the discharge region, via two

processes: the electron impact dissociation ($e + H_2 \Rightarrow e + 2H$), as shown in Fig. 2(b), and the ion-molecule reaction ($H_2^+ + H_2 \Rightarrow H_3^+ + H$), as shown in Fig. 2(c). We also notice that in the processing region, the generation rate of the H atoms, g_H , is negligibly small. This is because the electron temperature is rather low compared with the threshold energy of the electron impact dissociation. As for the loss of H atoms, the electron attachment ($e + H \Rightarrow H^-$), shown in Fig. 2(d), is negligibly small, compared with the generation. The loss of H atoms is thus dominated by the surface recombination on the electrode. In the presentation, more details of experimental and simulation results are presented.

[1] S. Takashima, M. Hori, T. Goto and K. Yoneda, *J. Appl. Phys.* **89** (2001) 4727.

[2] S. Nunomura, H. Katayama and I. Yoshida, *Plasma Sources Sci. Technol.* **26** (2017) 055018.

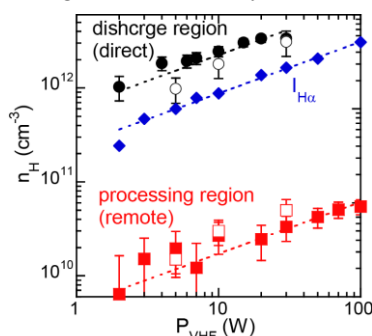


Fig. 1. H atom density, n_H , & Balmer emission intensity, $I_{H\alpha}$, vs. the discharge power, P_{VHF} at H₂ gas pressure of $p = 0.3$ Torr.

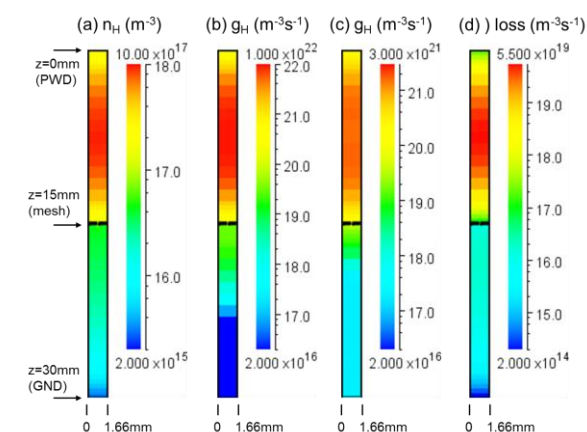


Fig. 2. Contour plots of hydrogen (H) atom related parameters [2]. (a) H atom density, n_H , (b) H atom generation rate, g_H , associated with the electron impact dissociation ($e + H_2 \Rightarrow e + 2H$) (c) H atom generation rate, associated with the ion-molecule reaction ($H_2^+ + H_2 \Rightarrow H_3^+ + H$) and (d) H atom loss rate due to the electron attachment, $e + H \Rightarrow H^-$. The simulation space includes two unit cells of the mesh structure in the horizontal axis of 0 – 1.66 mm.